

Product Data

Preheater

Model : 853

Code : 4003 - 0028



Features

Rapid heating only 10s to reach 250 degree

Built- in temperature sensor, stable output temperature

Cool or hot air can be selected to preheat or cool chips

The preheater can be used with rework stations to process BGA or other flake ICs.

Technical Specification

Power	460 W
Temperature range	120 - 250 °C
Air Volume	0.18 m ³ / min
Dimension	100 (L) x 160 (W) x 170 (H) mm
Weight	About 1.0 kg (Including power cord)

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